



1SV234 — Silicon Epitaxial Type PIN Diode for VHF, UHF, AGC Applications

Features

- Series connection of 2 elements in an ultrasmall package facilitates high-density mounting and permits 1SV234-applied equipment to be made smaller
- Small interterminal capacitance (C=0.23pF typ)
- Small forward series resistance (rs=5Ω typ)

Specifications

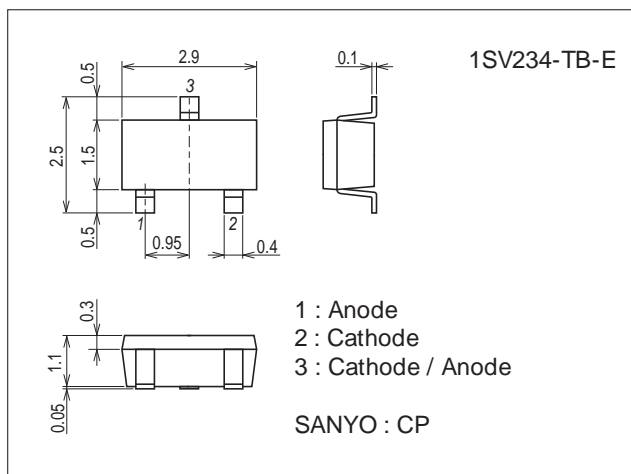
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Reverse Voltage	V _R		50	V
Forward Current	I _F		50	mA
Allowable Power Dissipation	P		150	mW
Junction Temperature	T _J		125	°C
Storage Temperature	T _{stg}		-55 to +125	°C

Package Dimensions

unit : mm (typ)

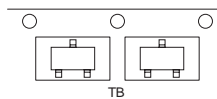
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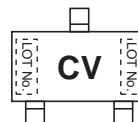
Product & Package Information

- Package : CP
- JEITA, JEDEC : SC-59, TO-236, SOT-23, TO-236AB
- Minimum Packing Quantity : 3,000 pcs./reel

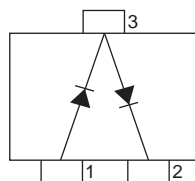
Packing Type: TB



Marking



Electrical Connection



1SV234

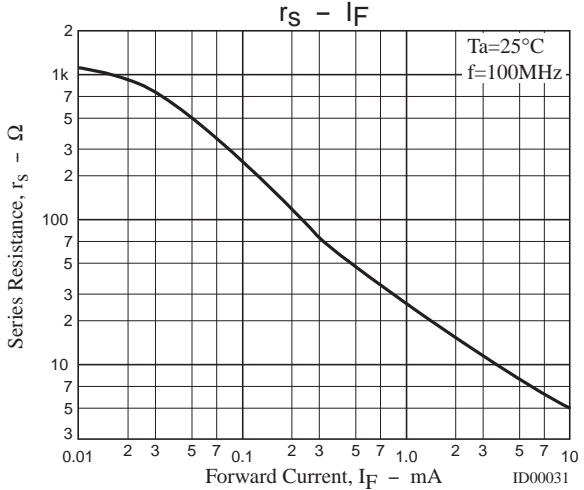
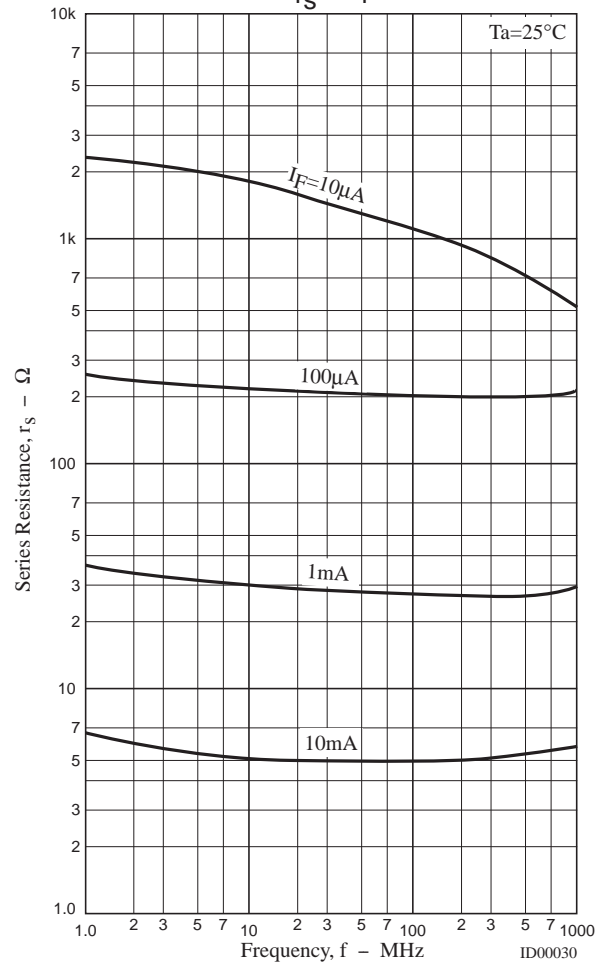
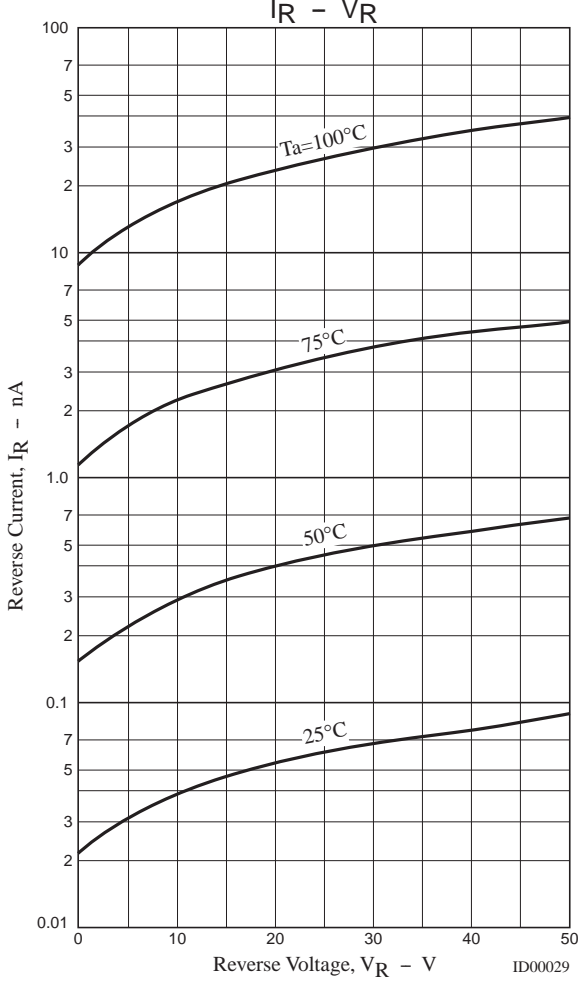
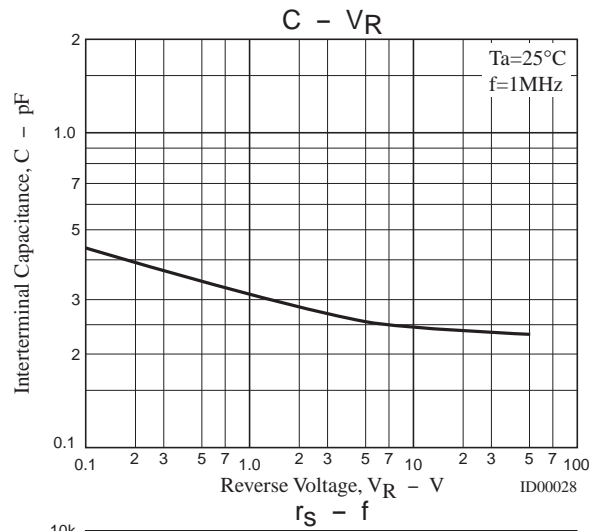
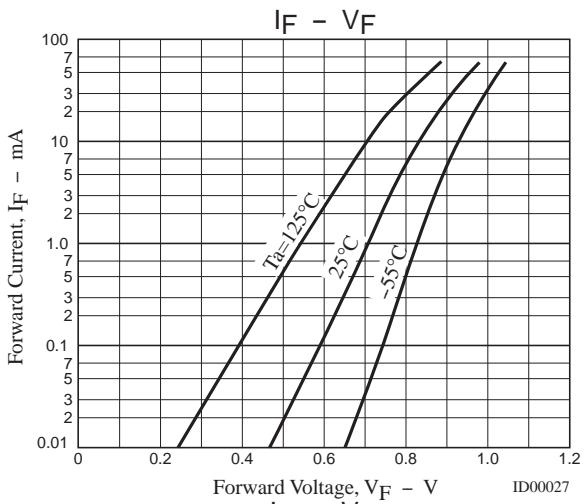
Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Reverse Voltage	V _R	I _R =10μA	50			V
Reverse Current	I _R	V _R =50V			0.1	μA
Forward Voltage	V _F	I _F =50mA		0.95		V
Interterminal Capacitance	C	V _R =50V, f=1MHz		0.23		pF
Series Resistance	r _s	I _F =10mA, f=100MHz		5		Ω

Note : The specifications shown above are for each individual diode.

Ordering Information

Device	Package	Shipping	memo
1SV234-TB-E	CP	3,000pcs./reel	Pb Free



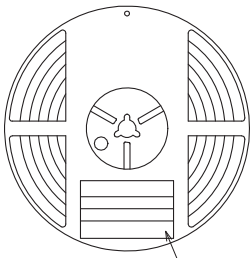
Embossed Taping Specification

1SV234-TB-E

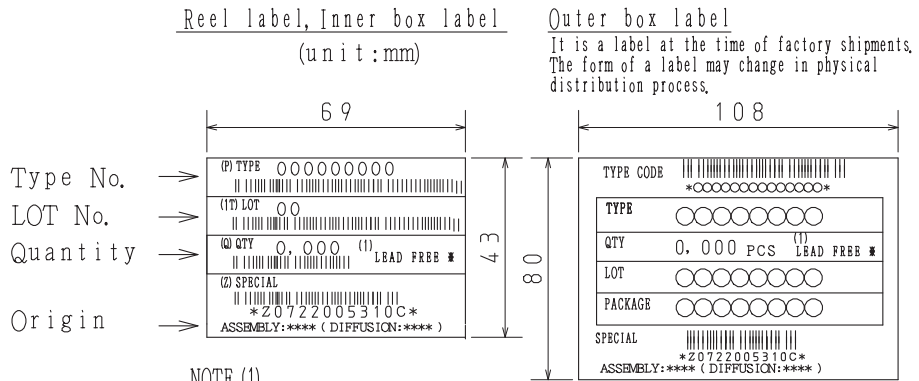
1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
CP	CP	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Packing method



Reel label



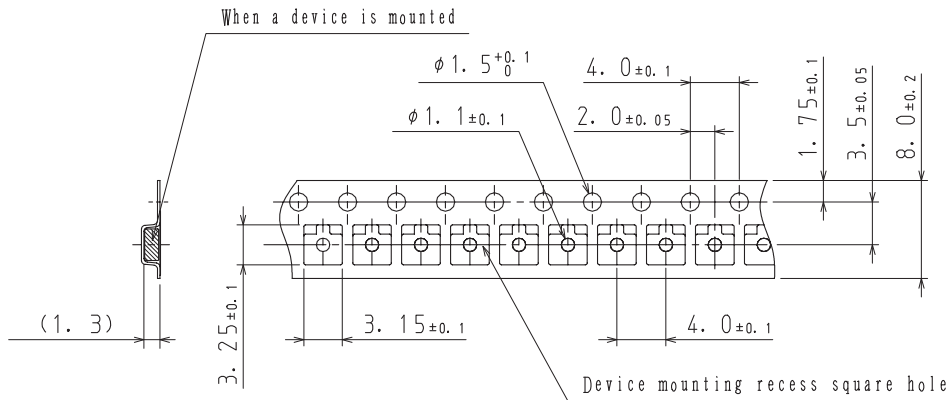
NOTE (1)

The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

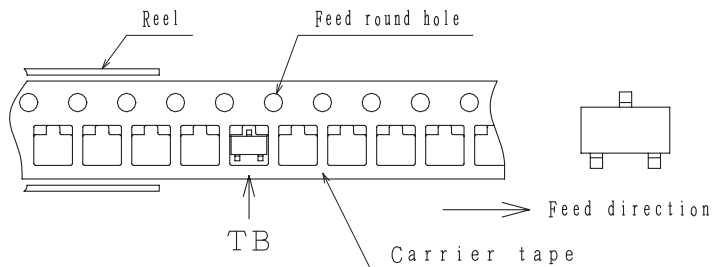
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



2-2. Device placement direction

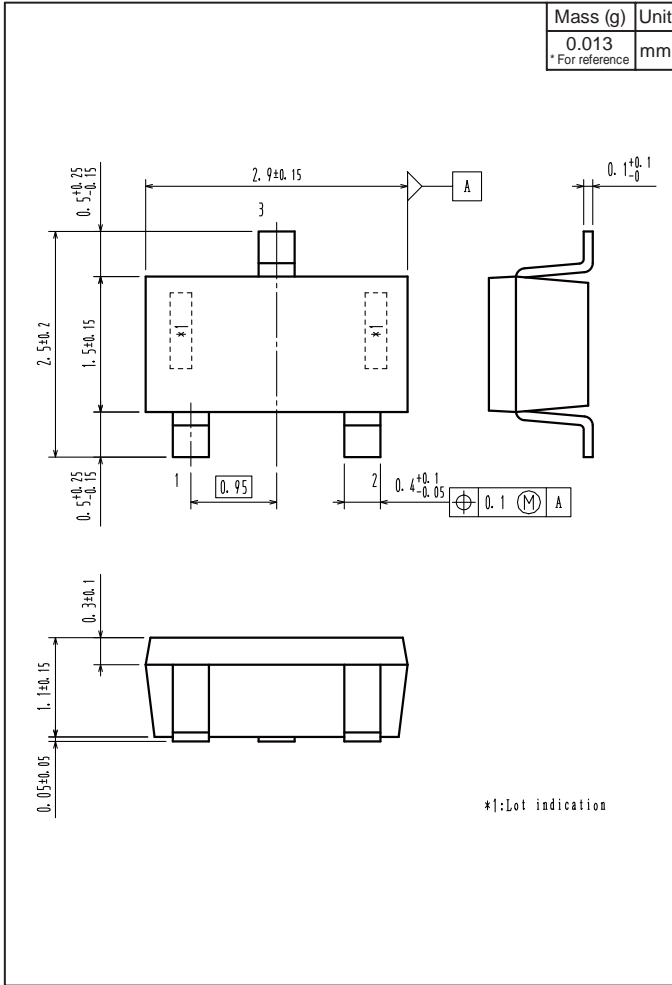


Those with one electrode terminal on the feed hole side.....TB

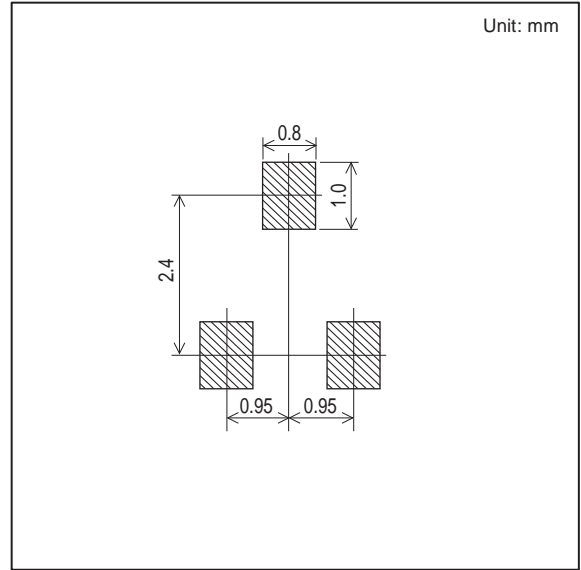
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Outline Drawing

1SV234-TB-E



Land Pattern Example



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